Heraeus

Technical Data Sheet



THICK FILM MATERIALS

Product Type: Conductors

Product Name: C5020



Gold Conductor Paste

Description

C5020 is an unfritted lead, nickel and cadmium free gold conductor. It is designed for application on top of a gold based layer to increase thickness and solderability.

In a single print and fire application on a gold base layer it yields a thick, dense film that is free from blisters, cracks, and other cosmetic defects.

C 5020 has good adhesion when printed over a gold base layer of Heraeus Au conductors. It is not designed to be used without a gold base layer.

Key Benefits

- Excellent choice for higher conductivity applications that require thick gold conductor
- Free of lead, cadmium and nickel

Processing

1) Spatulate well prior to processing.

When stored in a fridge: The paste should have acquired room temperature before being opened, to avoid condensation.

- 2) Print through a 200 325 mesh stainless steel screen.
- 3) Level at room temperature for 10 minutes.
- 4) Dry at 125 150 °C for 10 20 minutes.
- 5) Fire at 550 950 °C (peak) for 10 minutes, and with a total firing cycle time of c. 30 60 minutes.

Thinner

HVS 100

Typical Properties (Paste)

Form Pseudoplastic paste

Viscosity 35 – 55 Pas

 $(25 \, ^{\circ}\text{C}, \, D = 75/\text{s})$

Printing Speed Up to at least 10 cm/s

Coverage Approx. 50 cm²/g (FFT: 8 μm)

Shelf Life 6 months from date of shipment

with correct storage (in a dry, cool (5 to 25 °C) and dark place with

container tightly shut).

Typical Properties (Fired)¹

Fired Film Thickness² $6 - 10 \mu m$

(FFT)

Line Definition $\geq 100 \ \mu m$

Resistivity² $\leq 4.5 \text{ m}\Omega/\Box \text{ (FFT: 8 }\mu\text{m)}$



Technical Data Sheet



Gold Conductor Paste

Legend:

- Typical property based on laboratory test methods. For optimum results all materials should be fired in a profiled furnace supplied with dried, hydrocarbon and other contaminant free air (PP-1).
- $^{2)}$ Measured after printing with a 325 mesh steel screen; screen thickness and emulsion thickness combined was c. 75 $\mu m_{\rm s}$ and the resultant printed track was 500 μm wide.
- * See the data sheet issue date (DD/MM/YY) as reference of validity of latest edition which is available on request

Heraeus Electronics Heraeus Deutschland GmbH & Co. KG Heraeusstraße 12 – 14 63450 Hanau, Germany www.heraeus-electronics.com

Americas

Phone +1 610 825 6050 electronics.americas@heraeus.com

Asia Pacific

Phone +65 6571 7649 electronics.apac@heraeus.com

China

Phone +86 53 5815 9601 electronics.china@heraeus.com

Europe, Middle East and Africa Phone +49 6181 35 4370 electronics.emea@heraeus.com